# **Refine Search**

### Search Results -

Terms	Documents	
L2 and polyimide	2	

Database:

US Pre-Grant Publication Full-Text Database
US Patents Full-Text Database
US OCR Full-Text Database
EPO Abstracts Database
JPO Abstracts Database
Derwent World Patents Index

IBM Technical Disclosure Bulletins

Search:

L3		Refine Search
Recall Text 👄	Clear	Interrupt

## **Search History**

**DATE:** Friday, June 25, 2004 Printable Copy Create Case

Set Name		Hit Count	<u>Set Name</u>
side by side	e		result set
DB=PC	GPB, USPT, USOC, EPAB, JPAB, DWPI; PLUR=YES; OP=ADJ		
<u>L1</u>	ishikawa-seiji\$.in. or hayashi-koji\$.in. or sonoyama-kenji\$.in.	1471	<u>L1</u>
<u>L2</u>	L1 and dicing	2	<u>L2</u>
<u>L3</u>	L2 and polyimide	2	<u>L3</u>

**END OF SEARCH HISTORY** 

# **Refine Search**

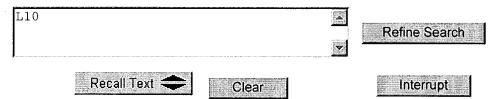
#### Search Results -

Terms	Documents
L9 and strength	13

US Pre-Grant Publication Full-Text Database US Patents Full-Text Database US OCR Full-Text Database **EPO Abstracts Database** Database: JPO Abstracts Database Derwent World Patents Index

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Search:



### **Search History**

DATE: Friday, June 25, 2004 Printable Copy Create Case

Set Name		<b>Hit Count</b>	Set Name	
side by side			result set	
DB=PGPB, USPT, USOC, EPAB, JPAB, DWPI; PLUR=YES; OP=ADJ				
<u>L1</u>	dicing	20543	<u>L1</u>	
<u>L2</u>	semiconductor	1401292	<u>L2</u>	
<u>L3</u>	polyimide	130445	<u>L3</u>	
<u>L4</u>	polyimidesiloxane or polyimidosiloxane or (polyimide with siloxane)	2155	<u>L4</u>	
<u>L5</u>	adhesive	1005794	<u>L5</u>	
<u>L6</u>	13 with L5	11314	<u>L6</u>	
<u>L7</u>	14 and L6	530	<u>L7</u>	
<u>L8</u>	11 and L7	17	<u>L8</u>	
<u>L9</u>	12 and L8	16	<u>L9</u>	
<u>L10</u>	19 and strength	13	<u>L10</u>	

#### END OF SEARCH HISTORY